AMENDMENTS TO THE CLAIMS

(Previously Presented) A method, comprising:

forming a metal particle of a size suitable for use as a catalyst in forming a nanotube by an electroless process in a bath; and

once formed, depositing the particle on a semiconductor substrate.

- (Original) The method of claim of 1, wherein the electrochemical process comprises an oxidation-reduction reaction.
- (Original) The method of claim 2, wherein the forming a metal particle comprises
 introducing an ionic precursor of the metal particle into a bath and reducing the ionic precursor
 by chemical reaction.
- (Original) The method of claim 1, wherein forming the metal particle comprises forming an alloy.
- (Original) The method of claim 4, wherein forming the alloy comprises forming a Group VIII metal alloy.
- (Original) The method of claim 4, wherein forming the alloy comprises forming a Group VI metal alloy.
- (Original) The method of claim 4, wherein forming the alloy comprises forming an alloy including a Group VIII metal and a Group VI metal.

Claims 8-35 (Canceled)

36. (Previously Presented) The method of claim 1, wherein prior to depositing the particle, the method further comprises immersing the substrate in the bath.

- 37. (Previously Presented) The method of claim 1, wherein depositing the particle comprises dispensing the bath comprising the particle on the substrate.
- 38. (Previously Presented) The method of claim 1, wherein prior to depositing the particle, the method comprises extracting the particle from the bath.
- 39. (Previously Presented) The method of claim 1, wherein forming a metal particle in a bath comprises mixing metal ions from Group VIII and metal ions from Group VI with one or more reducing agents.
- 40. (Previously Presented) The method of claim 39, wherein the one or more reducing agents are alkaline metal-free reducing agents.